- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

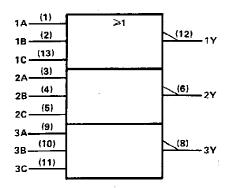
These devices contain three independent 3-input NOR gates.

The SN5427 and SN54LS27 are characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to 125 $\,^{\circ}\text{C}$. The SN7427 and SN74LS27 are characterized for operation from 0 $\,^{\circ}\text{C}$ to 70 $\,^{\circ}\text{C}$.

FUNCTION TABLE (each gate)

11	NPUT	s	OUTPUT
A	В	С	Y
Н	х	х	Ļ
Х	Н	х	L
X	Х	н	L
L	L	L	Н ,

logic symbol †



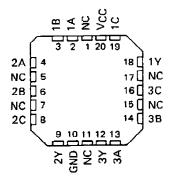
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5427, SN54LS27...J OR W PACKAGE SN7427...N PACKAGE SN74LS27...D OR N PACKAGE (TOP VIEW)

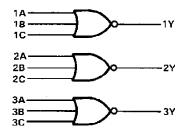
1A 🗆	1	U14] Vcc
1B 🗖	2	13] 1C
2A 🗆	3	12] 1Y
2B 🖂	4	11 🗀 3C
2C 🗖	5	10 3B
2Y 🗖	6	9 🗍 3A
GND 🗖	7	8 🗍 3Y

SN54LS27 . . . FK PACKAGE (TOP VIEW)



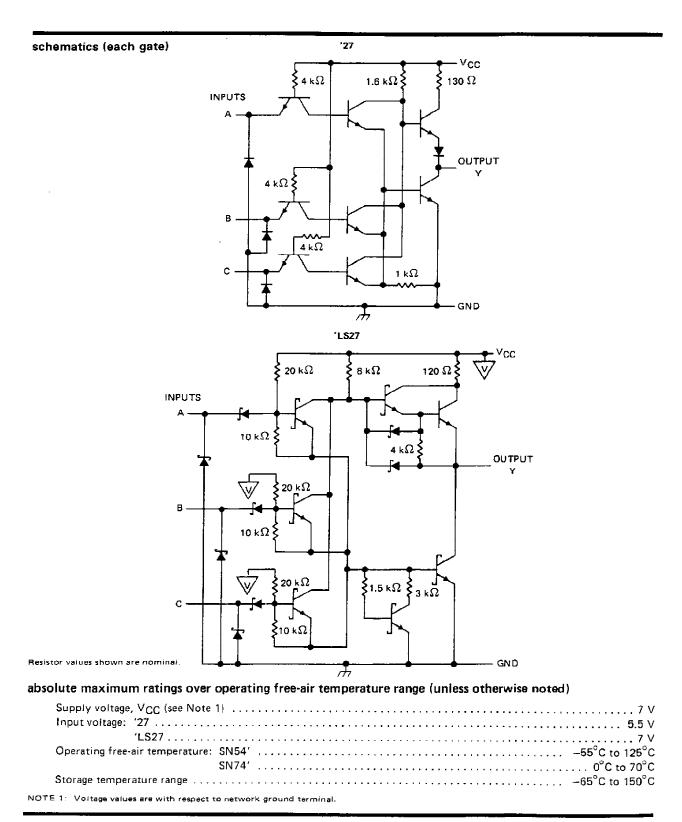
NC - No internal connection

logic diagram



positive logic

 $Y = \overline{A + B + C}$ or $Y = \overline{A \cdot B \cdot C}$



recommended operating conditions

			SN5427			SN7427			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VGC	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧	
v_{IH}	High-level input voltage	2	•		2			٧	
V_{1L}	Low-level input voltage			8,0			0.8	V	
loн	High-level output current			0.8			- 0.8	mΑ	
ĵοL	Low-level output current			16			16	mΑ	
ŤA	Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

 PARAMETER	TEST CONDITIONS †					•				
PANAMETER			110143	MIN	TYP ‡	MAX	MIN	түр‡	MAX	UNIT
Vικ	V _{CC} = MIN,	I ₁ = - 12 mA				- 1.5			- 1.5	٧
VOH	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = -0.8 mA	2.4	3.4		2.4	3.4		V
VOL	VCC = MIN,	V _{IH} = 2 V,	I _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
t _l	V _{CC} = MAX,	V ₁ = 5.5 V				1			1	mA
ήн	V _{CC} = MAX,	V ₁ = 2.4 V			•	40			40	μΑ
l) L	V _{CC} = MAX,	V1 = 0.4 V	-			- 1.6			- 1.6	mA
10\$ §	V _{CC} = MAX			- 20		- 55	- 18		– 55	mA
Іссн	VCC = MAX,	VI = 0 V			10	16		10	16	mA
¹ CCL	V _{CC} = MAX,	See Note 2			16 ,	26		16	26	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONI	MIN	TYP	MAX	UNIT	
tPLH	A, B or C	v	R _L = 400 Ω,	C 16 nE		10	15	ns
tpHL	A, B or C	'	$R_L = 400 \Omega$, $C_L = 15 pF$		7	11	ns	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. § Not more than one output should be shorted at a time.

SN54LS27, SN74LS27 TRIPLE 3-INPUT POSITIVE-NOR GATES

recommended operating conditions

•		S	N54LS2	54LS27 SN74LS27			UNIT	
_		MIN	NOM	MAX	MIN	NOM	MAX	CNII
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			٧
VIL	Low-level input voltage			0.7			0.8	٧
Іон	High-level output current			- 0.4			- 0.4	mΑ
loL	Low-level output current			4			В	mA
TΑ	Operating free-air temperature	– 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS †		SN54LS27			S				
PARAMETER		1591 CONDI	TIUNA I	MIN	TYP‡	MAX	MIN	TYP ‡	MAX	TINU
۷ıĸ	VCC = MIN.	I _I = 18 mA				- 1.5			— 1.5	>
∨он	V _{CC} - MIN,	V _{IL} = MAX,	1 _{OH} = - 0.4 mA	2.5	3.4		2.7	3.4		>
.,	VCC = MIN,	V _{1H} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	IOL = 8 mA					0.35	0.5	
l _l	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
Чн	VCC = MAX,	V ₁ = 2.7 V				20			20	μΑ
lit	V _{CC} = MAX,	V _I = 0.4 V	*			- 0.4			0.4	mA
los §	V _{CC} = MAX			- 20		- 100	20		– 100	mA
Іссн	V _{CC} = MAX,	V _I = 0 V			2	4		2	4	mA
lCCL	VCC = MAX.	See Note 2			3.4	6.8		3.4	6.8	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	MAX	UNIT	
tPLH	A B == C	V	B 2 kg	C 15 - C		10	15	пѕ
t _{PHL}	A, B or C	, r	R _L = 2 kΩ,	C _L = 15 pF		10	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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